











PRODUCT DATASHEET



- ► PLCC2
- ► K1 Series
- ► Green (520-535nm)

N0G06S21 (Tube) N0G06S21RL (Reel)





K1 Series





FEATURES:

• Package: PLCC White SMT Package

Forward Current: 350mAForward Voltage (typ.): 3.4V

• Luminous Flux (typ.): 75lm @350mA

• Colour: Green

Wavelength: 520-535nmViewing angle: 155°

• Materials:

Die: InGaN

Resin: Silicon (Water Clear)

• Operating Temperature: -30~+100°C

• Storage Temperature: -40~+120°C

Grouping parameters:

Forward voltage

Luminous flux

Wavelength

• Soldering methods: Reflow soldering

• Preconditioning: acc. to JEDEC Level 3

Packing: 2000pcs/carton (40 tubes); 50pcs/tube

24mm tape with 1000pcs/reel, ø330mm (13")

APPLICATIONS:

- General Lighting
- Commercial LightingResidential Lighting
- Architectural Lighting
- Flash Lighting
- Reading Lights



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	I _F	350	mA
Peak Forward Current Duty 1/10@10KHz	I _{FP}	500	mA
Operating Temperature	T _{OPR}	-30~+100	°C
Storage Temperature	T _{STG}	-40~+120	°C
Junction Temperature	Tj	110	°C
Temperature Coefficient of VF	$\Delta V_F/\Delta T_j$	-2	mV/°C
Thermal Resistance Junction to Lead	T _{juction-lead}	12	°C/W

^{1.} Not suitable to be driven in reverse bias.

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol		Values	Unit	Test		
Parameter	Зуппоп	Min. Typ.		Max.	Offic	Condition	
Forward Voltage	V_{F}	3.0	3.4	3.6	V	I _F =350mA	
Luminous Flux	Φ_{V}	57	75		lm	I _F =350mA	
Dominant Wavelength	λ_{d}	520		535	nm	I _F =350mA	
Viewing Angle	2θ _{1/2}		155		deg	I _F =350mA	

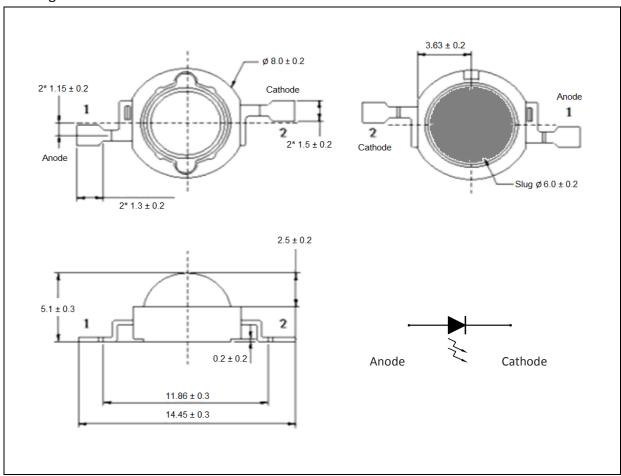
^{2.} Luminous intensity (Iv) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$

^{3.} IS standard testing



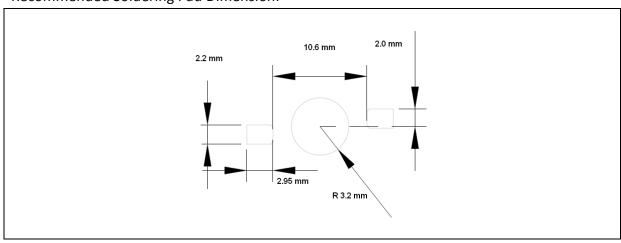
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications ($I_F = 350mA$):

Code	Min.	Max.	Unit
1	3.0	3.1	
2	3.1	3.2	
3	3.2	3.3	V
4	3.3	3.4	V
5	3.4	3.5	
6	3.5	3.6	

Luminous Flux Classifications ($I_F = 350$ mA):

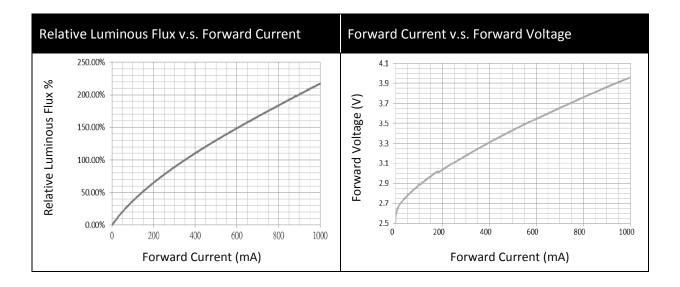
Code	Min.	Max.	Unit
15	55	65	
16	65	75	lm
17	75	85	lm
18	85	95	

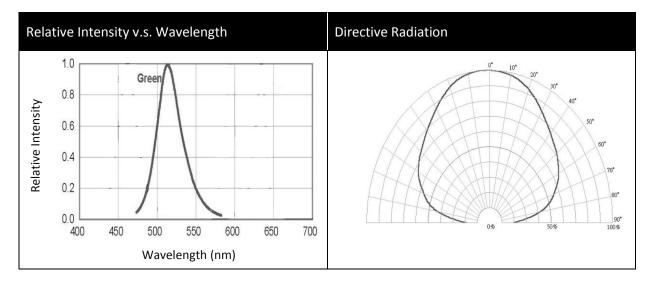
Wavelength Classifications ($I_F = 350mA$):

Code	Min.	Max.	Unit
G1	520	525	
G2	525	530	nm
G3	530	535	



ELECTRO-OPTICAL CHARACTERISTICS:

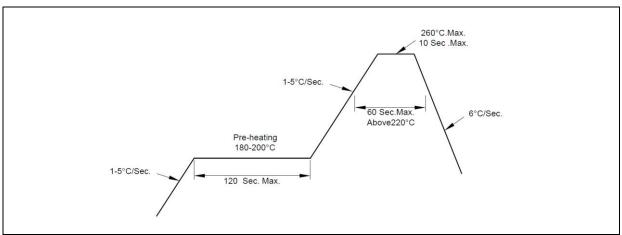






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



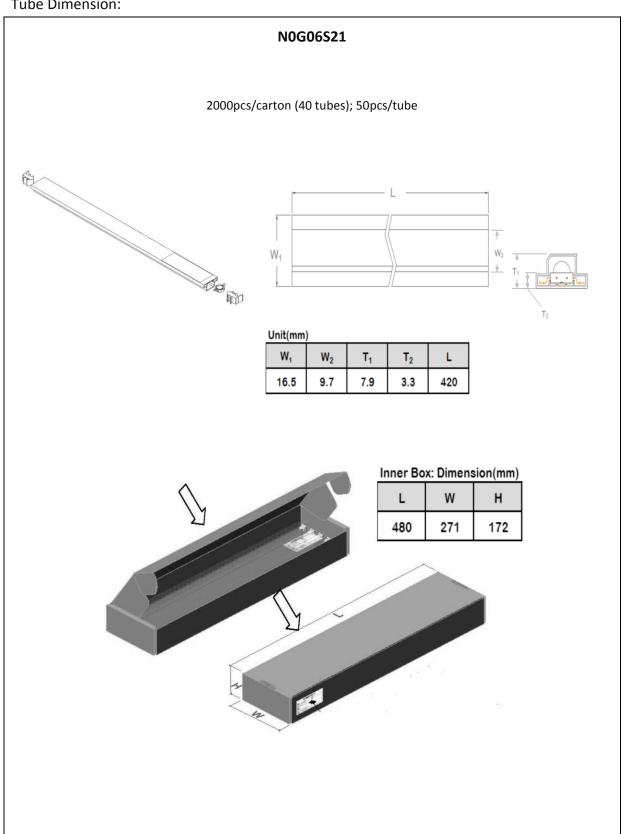
Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

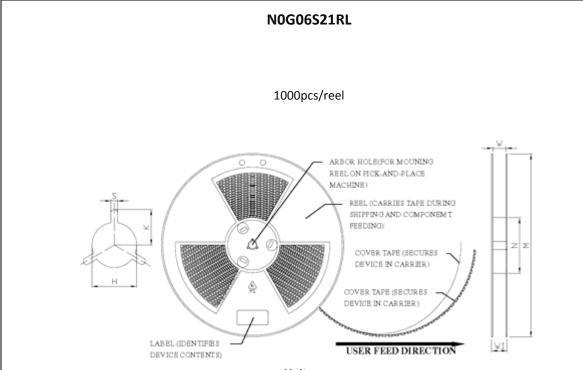
Tube Dimension:





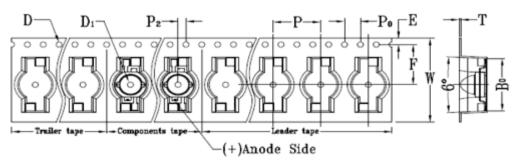
PACKING SPECIFICATION:

Reel Dimension:



Unit: mm

М	N	W	W1	Н	K	S
Ф330.0	Ф99.5	24.4	29	Ф13.5	10.75	2.5
±1.0	±1.0	±1.0	±1.0	±0.5	±0.5	±0.5



Unit: mm

W	Р	E	F	P ₂	D	D_1	P_0	A_0	B ₀	K_0	Т
24.0	12.0	1.75	11.5	2.0	1.5	1.5	4.0	8.2	15.0	6.7	0.4
±0.3	±0.1	±0.1	±0.1	±0.1	±0.1	±0.25	±0.1	±0.1	±0.1	±0.1	±0.05



PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

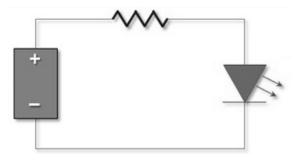
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

- 70±3°C x 24hrs and <5%RH, taped / reel package.
- 100±3°C x 2hrs, bulk (loose) package.
- 130±3°C x 30min, bulk (loose) package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision				
A1.0	14/04/2014	Datasheet set-up.				
A1.1	27/05/2014	Add reel packing information.				